BB149

UHF variable capacitance diode

Rev. 6 — 5 September 2011

Product data sheet

1. Product profile

1.1 General description

The BB149 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure. The unmatched type, BB159 has the same specification.

1.2 Features and benefits

- Excellent linearity
- Excellent matching to 1 % DMA
- Very small SMD plastic package
- $C_{d(28V)}$: 2.1 pF; $C_{d(1V)}$ to $C_{d(28V)}$ ratio: 9
- Low series resistance.

1.3 Applications

- Electronic tuning in UHF television tuners
- Voltage Controlled Oscillators (VCO).

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline[1]	Symbol
1	cathode		II
2	anode	1 2	-
_	anous		

^[1] Marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB149	SC-76	plastic surface mounted package; 2 leads	SOD323



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4. Marking

Table 3. Marking

Type number	Marking code
BB149	P9

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

			•		
Symbol	Parameter	Conditions	Min	Max	Unit
V_R	reverse voltage		-	30	V
I _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

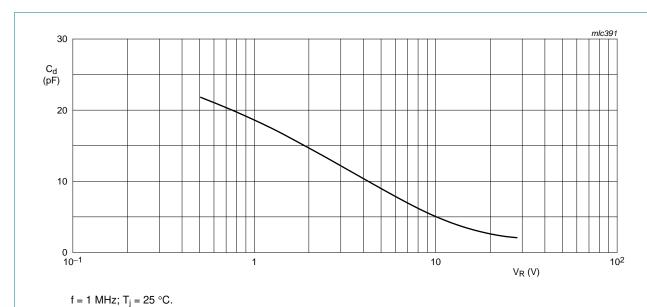
Table 5. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I_R	reverse current	see Figure 2				
		$V_R = 30 \text{ V}$	-	-	10	nA
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	-	-	200	nA
r _s	diode series resistance	f = 470 MHz	[1] -	-	0.75	Ω
C _d diode		f = 1 MHz; see Figure 1 and 3				
capacitance	capacitance	V _R = 1 V	18	-	19.5	pF
		V _R = 28 V	1.9	2.1	2.25	pF
$\frac{C_{d(1V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	8.2	9	10	
$\frac{C_{d(19V)}}{C_{d(28V)}}$	capacitance ratio	f = 1 MHz	1.2	-	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 0.5 \text{ V}$ to 28 V; in a sequence of 10 diodes (gliding)	-	-	2	%

^[1] V_R is the value at which $C_d = 9$ pF.

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Diode capacitance as a function of reverse voltage; typical values.

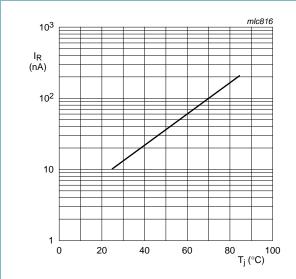
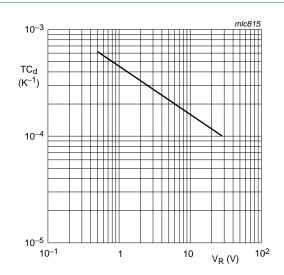


Fig 2. Reverse current as a function of junction temperature; maximum values.



 $T_i = 0$ °C to 85 °C.

Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

Fig 1.

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7. Package outline

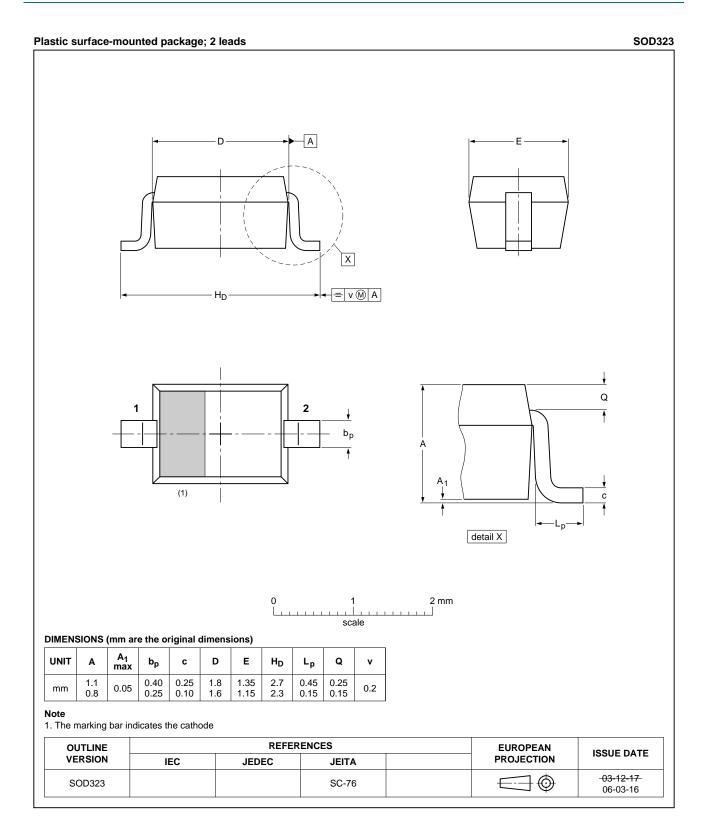


Fig 4. Package outline SOD323 (SC-76).

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8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB149 v.6	20110905	Product data sheet	-	BB149 v.5
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	with the new identity
	 Legal texts 	have been adapted to the n	ew company name whe	ere appropriate.
	 Package out 	ıtline drawings have been u	odated to the latest ver	sion.
BB149 v.5 (9397 750 13825)	20041004	Product data sheet	-	BB149 v.4
BB149 v.4 (9397 750 12653)	20040301	Product specification	-	BB149 v.3
BB149 v.3 (9397 750 04378)	19980915	Product specification	-	BB149 v.2
BB149 v.2	19960503	n.a.	-	BB149 v.1
BB149 v.1	19941209	n.a.	-	-

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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